Product data sheet

### 1. Product profile

### 1.1 General description

Planar PIN diode in a SOD323 (SC-76) small SMD plastic package.

#### 1.2 Features and benefits

- High voltage current controlled RF resistor for attenuators
- Low diode capacitance
- Very low series inductance

### 1.3 Applications

- RF attenuators
- (SAT) TV
- Car radio

## 2. Pinning information

Table 1. Discrete pinning

Pin	Description	Simplified outline	Graphic symbol
1	cathode	. 🔙	14
2	anode		<del>1/1</del>
			sym006

# 3. Ordering information

Table 2. Ordering information

Type number	Package			
	Name	Description	Version	
BAP70-03	-	plastic surface-mounted package; 2 leads	SOD323	

# 4. Marking

Table 3. Marking

- and or an analysis			
	Type number	Marking code	
	BAP70-03	A9	



Silicon PIN diode

# 5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_R$	reverse voltage	continuous voltage	-	50	V
I <sub>F</sub>	forward current	continuous current	-	100	mA
P <sub>tot</sub>	total power dissipation	T <sub>sp</sub> = 90 °C	-	500	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		-65	+150	°C

### 6. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		120	K/W

### 7. Characteristics

#### Table 6. Characteristics

 $T_{amb} = 25$  °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 50 mA	-	0.9	1.1	V
I <sub>R</sub>	reverse current	V <sub>R</sub> = 50 V	-	-	100	nA
C <sub>d</sub>	diode capacitance	see Figure 1; f = 1 MHz;				
		$V_R = 0 V$	-	570	-	fF
		V <sub>R</sub> = 1 V	-	400	-	fF
		V <sub>R</sub> = 5 V	-	270	-	fF
		V <sub>R</sub> = 20 V	-	200	250	fF
r <sub>D</sub>	diode forward resistance	see Figure 2; f = 100 MHz;				
		I <sub>F</sub> = 0.5 mA	-	77	100	Ω
		I <sub>F</sub> = 1 mA	-	40	50	Ω
		I <sub>F</sub> = 10 mA	-	5.4	7	Ω
		I <sub>F</sub> = 100 mA	-	1.4	1.9	Ω
τ∟	charge carrier life time	when switched from I <sub>F</sub> = 10 mA to I <sub>R</sub> = 6 mA; R <sub>L</sub> = 100 $\Omega$ ; measured at I <sub>R</sub> = 3 mA	-	1.25	-	μS
L <sub>S</sub>	series inductance	I <sub>F</sub> = 100 mA; f = 100 MHz	-	1.5	-	nΗ

Silicon PIN diode

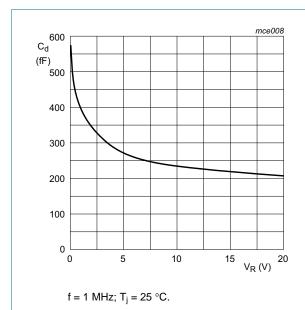


Fig 1. Diode capacitance as a function of reverse voltage; typical values

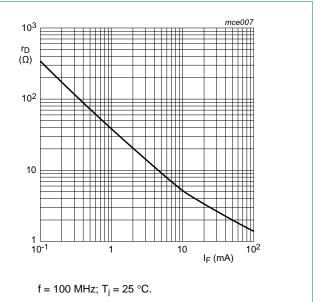


Fig 2. Diode forward resistance as a function of forward current; typical values

#### Silicon PIN diode

# 8. Package outline

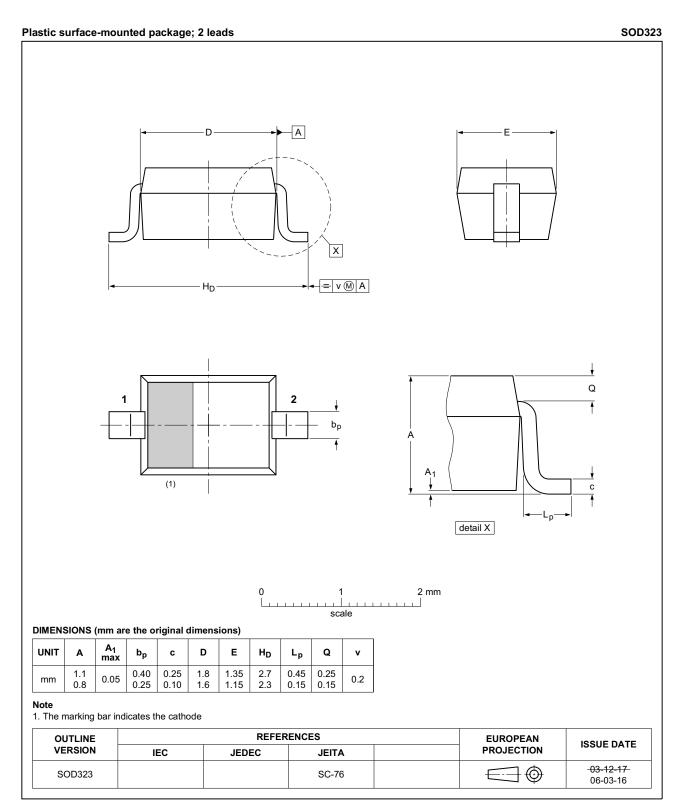


Fig 3. Package outline SOD323

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### Silicon PIN diode

## 9. Abbreviations

Table 7. Abbreviations

Acronym	Description
PIN	P-type, Intrinsic, N-type
SMD	Surface Mounted Device
RF	Radio Frequency
SAT	SATellite

# 10. Revision history

### Table 8. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BAP70-03 v.6	20140307	Product data sheet	-	BAP70-03_N v.5
Modifications:		of this data sheet has been red f NXP Semiconductors.	designed to comply with	the new identity
	<ul> <li>Legal texts h</li> </ul>	nave been adapted to the new	company name where	appropriate.
BAP70-03_N v.5	20070327	Product data sheet	-	BAP70-03 v.4
BAP70-03 v.4 (9397 750 12636)	20040210	Product data sheet	-	BAP70-03 v.3
BAP70-03 v.3 (9397 750 10094)	20020806	Product data sheet	-	BAP70-03_N v.2
BAP70-03_N v.2 (9397 750 10081)	20020702	Preliminary data sheet	-	BAP70-03_N v.1
BAP70-03_N v.1 (9397 750 09579)	20020402	Preliminary data sheet	-	-

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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